# imall

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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# FAIRCHILD

SEMICONDUCTOR®

# **SGL40N150D**

## **General Description**

Fairchild's Insulated Gate Bipolar Transistor (IGBT) provides low conduction and switching losses. The SGL40N150D is designed for induction heating applications.

### **Features**

- High speed switching
- Low saturation voltage :  $V_{CE(sat)} = 3.7 \text{ V} @ I_C = 40 \text{ A}$
- High input impedance
- Built-in fast recovery diode

## **Applications**

Home appliances, induction heaters, IH JAR, and microwave ovens.



# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		SGL40N150D	Units
V <sub>CES</sub>	Collector-Emitter Voltage		1500	V
V <sub>GES</sub>	Gate-Emitter Voltage		± 25	V
	Collector Current	@ T <sub>C</sub> = 25°C	40	А
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100°C	20	А
I <sub>CM (1)</sub>	Pulsed Collector Current		120	А
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 100°C	10	А
I <sub>FM</sub>	Diode Maximum Forward Current		100	А
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	200	W
	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	80	W
TJ	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes: (1) Repetitive rating : Pulse width limited by max. junction temperature

# **Thermal Characteristics**

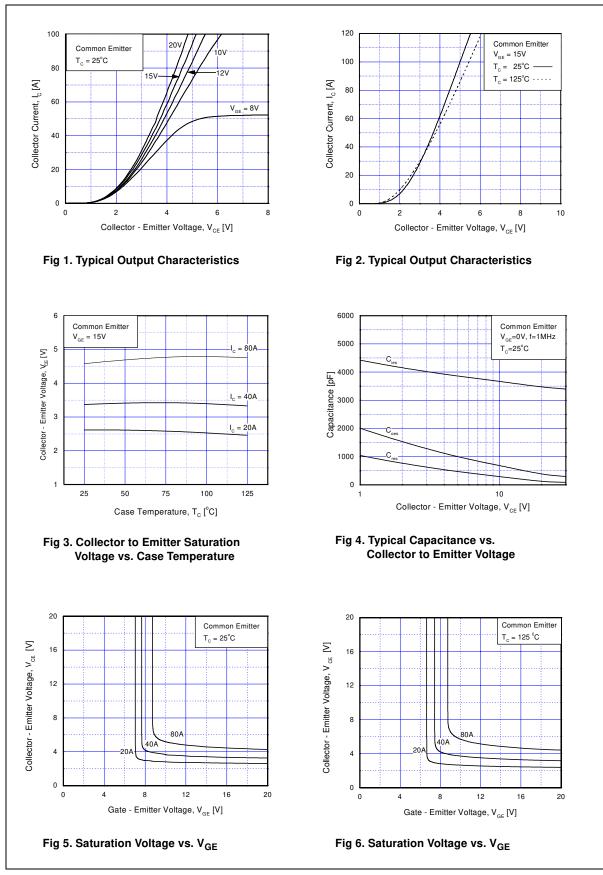
Symbol	Parameter	Тур.	Max.	Units
R <sub>θJC</sub> (IGBT)	Thermal Resistance, Junction-to-Case		0.625	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		0.83	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		25	°C/W

IGBT

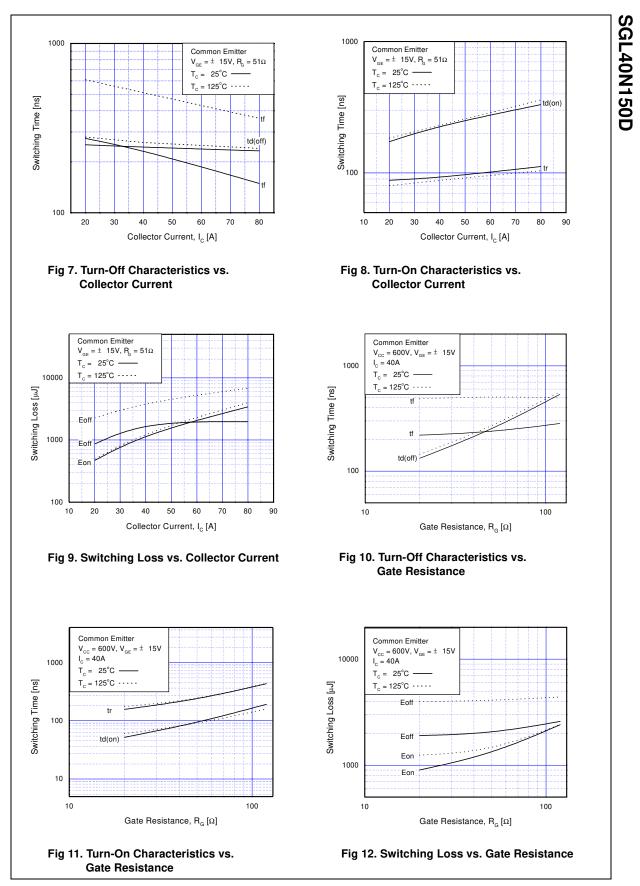
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	1500			V
ICES	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
IGES	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
	racteristics			1	1	
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_{C} = 40 \text{mA}, V_{CE} = V_{GE}$	3.5	5.0	7.5	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 40A, V <sub>GE</sub> = 15V		3.7	4.7	V
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0V, f = 1MHz		4000 700 300		pF pF pF
Switchi	ng Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	N/ 0001/1 /01		90	200	ns
t <sub>r</sub>	Rise Time	V <sub>CC</sub> = 600V, I <sub>C</sub> = 40A, R <sub>G</sub> = 51Ω, V <sub>GE</sub> = 15V,		230	700	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	- $R_G = 5122$ , $V_{GE} = 15V$ , - Resistive Load, $T_C = 25^{\circ}C$		245	400	ns
t <sub>f</sub> Q <sub>g</sub> Q <sub>ge</sub>	Fall Time			230	400	ns
Qg	Total Gate Charge	$V_{-} = 600 V_{-} = 40.0$		140	170	nC
$\cap$	Gate-Emitter Charge	− V <sub>CE</sub> = 600V, I <sub>C</sub> = 40A, − V <sub>GE</sub> = 15V		25	25	nC
Gge	Gate-Collector Charge			45	60	nC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 10A		1.3	1.8	V
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = 10A, di/dt = 200A/us		170	300	ns

SGL40N150D

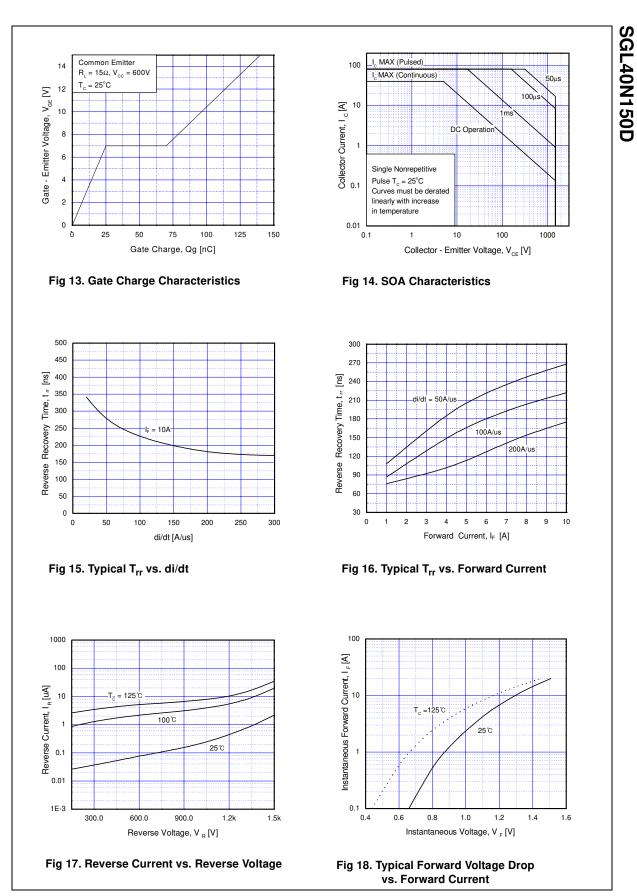


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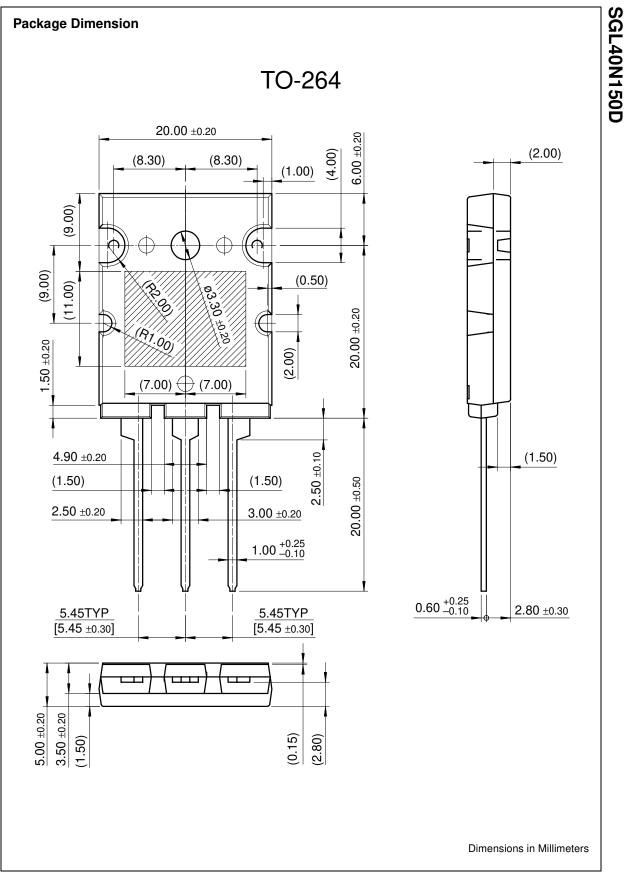
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